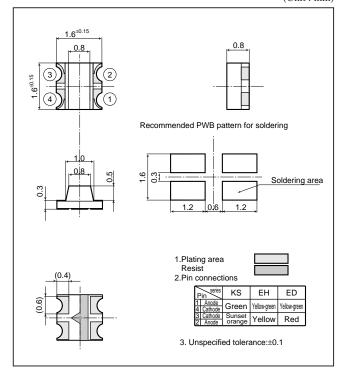
LT1□□67A series

1616 Size, 0.8mm Thickness, Compact Dichromatic Leadless Chip LED Devices

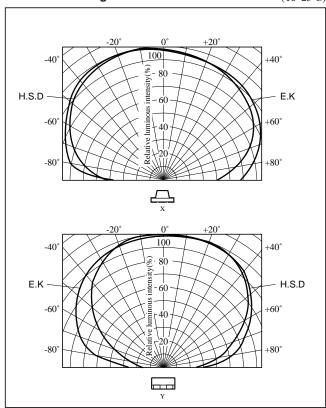
■ Outline Dimensions

(Unit: mm)



■ Radiation Diagram

(Ta=25°C)



■ Absolute Maximum Ratings*1

(Ta=25°C)

Model No.	Radiation color	Radiation material	Power dissipation Forward current P IF		Peak forward current IFM*2	Derating factor (mA/°C)		Reverse voltage V _R	Operating temperature $\mathbf{T}_{\mathrm{opr}}$	Storage temperature $T_{\rm stg}$	Soldering temperature T_{sol}^{*3}	
			(mW)	(mA)	(mA)	DC	Pulse	(V)	(°C)	(°C)	(°C)	
LT1EH67A	Yellow-green	GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350	
	Yellow	GaAsP on GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350	
LT1KS67A	Green	GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350	
	Sunset orange	GaAsP on GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350	
LT1ED67A	Yellow-green	GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350	
	Red	GaAsP on GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350	

^{*1} The value is specified under the condition that either color is lightened separately. When the both diodes are lightened simultaneously, the power dissipation of each diode should be less than the half of the value specified in this table.

■ Electro-optical Characteristics

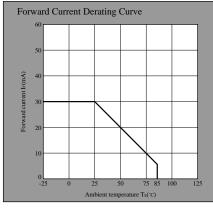
 $(T_a=25^{\circ}C)$

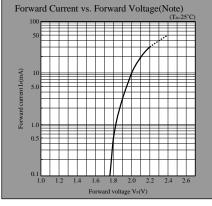
Lens type	Model No.	Radiation color	Forward voltage V _F (V)		Peak emission wavelength		Luminous intensity		Spectrum radiation bandwidth		Reverse current		Terminal capacitance		Page for
					$\lambda_p(nm)$ If		Iv(mcd) IF		Δλ(nm) If		Ir(µA) Vr		C _t (pF)	characteristics	
			TYP	MAX	TYP	(mA)	TYP	(mA)	TYP	(mA)	MAX	(V)	TYP	(MHz)	diagrams
Milky diffusion	LT1EH67A	Yellow-green	2.1	2.8	565	20	19.0	20	30	20	10	4	35	1	\rightarrow
		Yellow	2.0	2.8	585	20	8.3	20	30	20	10	4	35	1	\rightarrow
	LT1KS67A	Green	2.1	2.8	555	20	3.8	20	25	20	10	4	40	1	\rightarrow
		Sunset orange	2.0	2.8	610	20	6.9	20	35	20	10	4	15	1	\rightarrow
	III1⊫1167Δ ⊩	Yellow-green	2.1	2.8	565	20	19.0	20	30	20	10	4	35	1	\rightarrow
		Red	2.0	2.8	635	20	8.8	20	35	20	10	4	20	1	\rightarrow

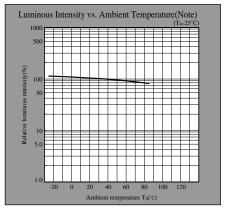
^{*2} Duty ratio=1/10, Pulse width=0.1ms

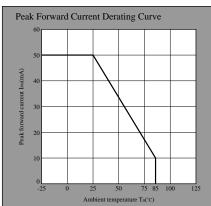
^{*3} For 3s or less at the temperature of hand soldering. Temperature of reflow soldering is shown on the below page.

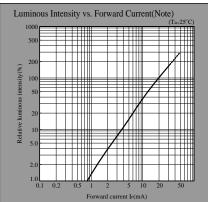
EG series

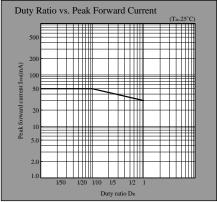




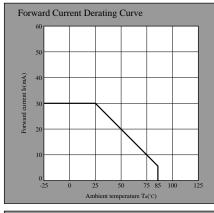


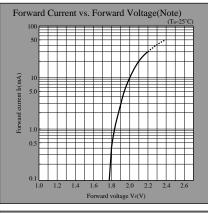


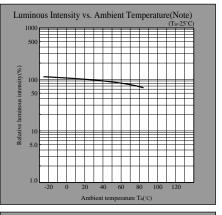


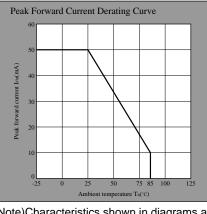


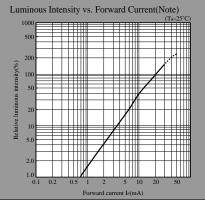
KG series

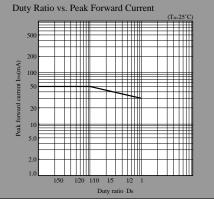








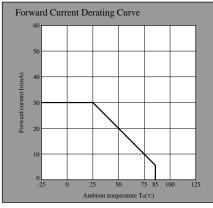


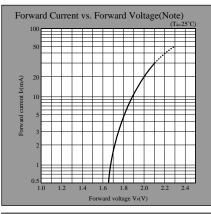


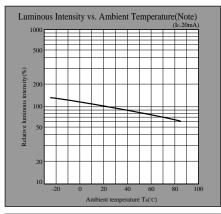
Note) Characteristics shown in diagrams are typical values. (not assurance value)

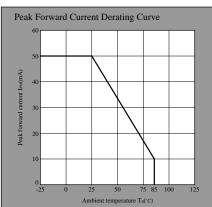
(Notice) • In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that may occur in equipment using any SHARP devices shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device.

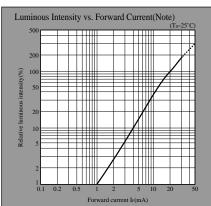
HS series

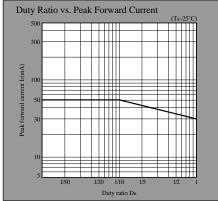




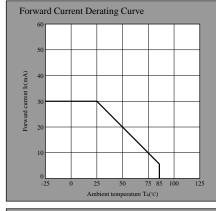


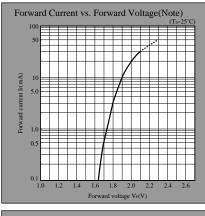


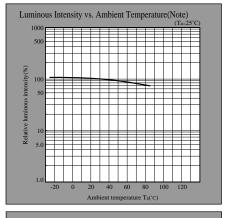


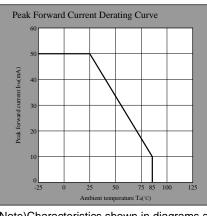


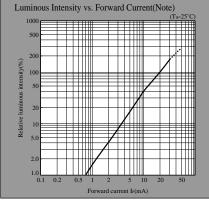
HY series

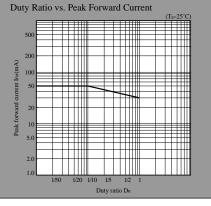








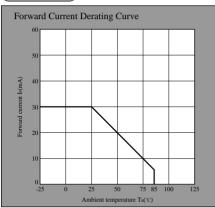


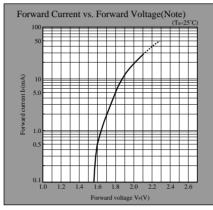


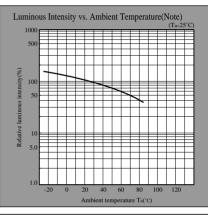
Note) Characteristics shown in diagrams are typical values. (not assurance value)

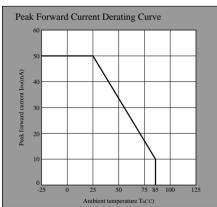
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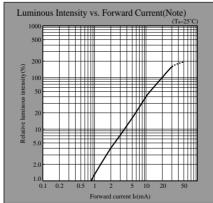
HD series

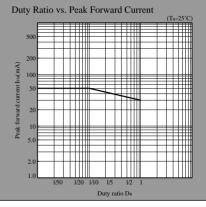












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